

General Description

The WSF30150 is the highest performance trench N-ch MOSFET with extreme high cell density, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications.

The WSF30150 meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

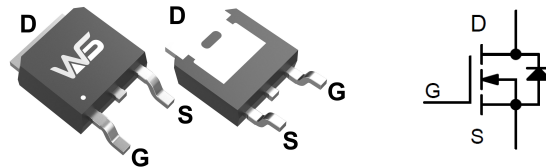
Product Summary

BVDSS	RDSON	ID
30V	2.3mΩ	110A

Applications

- Buck Converter
- Load Switch

TO-252 Pin Configuration



Absolute Maximum Ratings (TC=25°C unless otherwise specified)

Symbol	Parameter	Steady State	Units
V _{DS}	Drain-Source Voltage	30	V
V _{GS}	Gate-Source Voltage	±20	V
I _D @T _C =25°C	Continuous Drain Current, V _{GS} @ 10V ₁	110	A
I _D @T _C =100°C	Continuous Drain Current, V _{GS} @ 10V ₁	68	A
I _D @T _A =25°C	Continuous Drain Current, V _{GS} @ 10V ₁	19	A
I _D @T _A =70°C	Continuous Drain Current, V _{GS} @ 10V ₁	16	A
I _{DM}	Pulsed Drain Current ₂	192	A
EAS	Single Pulse Avalanche Energy ₃	144.7	mJ
I _{AS}	Avalanche Current	53.8	A
P _D @T _C =25°C	Total Power Dissipation ₄	62.5	W
P _D @T _A =25°C	Total Power Dissipation ₄	2.42	W
T _{STG}	Storage Temperature Range	-55 to 150	°C
T _J	Operating Junction Temperature Range	-55 to 150	°C
R _{θJA}	Thermal Resistance Junction-Ambient ₁	62	°C/W
R _{θJA}	Thermal Resistance Junction-Ambient ₁ (t ≤ 10s)	25	°C/W
R _{θJC}	Thermal Resistance Junction-Case ₁	2.4	°C/W

Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	30	---	---	V
ΔBV _{DSS} /ΔT _J	BVDSS Temperature Coefficient	Reference to 25°C , I _D =1mA	---	0.021	---	V/°C
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V , I _D =30A	---	2.3	4	mΩ
		V _{GS} =4.5V , I _D =15A	---	4.3	6	
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =250uA	1.2	1.6	2.5	V
ΔV _{GS(th)}	V _{GS(th)} Temperature Coefficient		---	-5.73	---	mV/°C
I _{DSS}	Drain-Source Leakage Current	V _{DS} =24V , V _{GS} =0V , T _J =25°C	---	---	1	uA
		V _{DS} =24V , V _{GS} =0V , T _J =55°C	---	---	5	
I _{GSS}	Gate-Source Leakage Current	V _{GS} =±20V , V _{DS} =0V	---	---	±100	nA
g _{fs}	Forward Transconductance	V _{DS} =5V , I _D =30A	---	26.5	---	S
R _g	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz	---	1.4	---	Ω
Q _g	Total Gate Charge (4.5V)	V _{DS} =15V , V _{GS} =4.5V , I _D =15A	---	70	---	nC
Q _{gs}	Gate-Source Charge		---	12	---	
Q _{gd}	Gate-Drain Charge		---	17	---	
T _{d(on)}	Turn-On Delay Time	V _{DD} =15V , V _{GS} =10V , R _G =3.3Ω I _D =15A	---	11	---	ns
T _r	Rise Time		---	120	---	
T _{d(off)}	Turn-Off Delay Time		---	25	---	
T _f	Fall Time		---	60	---	
C _{iss}	Input Capacitance	V _{DS} =15V , V _{GS} =0V , f=1MHz	---	3500	---	pF
C _{oss}	Output Capacitance		---	386	---	
C _{rss}	Reverse Transfer Capacitance		---	358	---	
I _S	Continuous Source Current ^{1,5}	V _G =V _D =0V , Force Current	---	---	90	A
I _{SM}	Pulsed Source Current ^{2,5}		---	---	360	A
V _{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =1A , T _J =25°C	---	---	1.2	V

Note :

- 1 .The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%
- 3.The EAS data shows Max. rating . The test condition is V_{DD}=25V,V_{GS}=10V,L=0.1mH,I_{AS}=53.8A
- 4 .The power dissipation is limited by 175°C junction temperature
- 5.The data is theoretically the same as I_D and I_{DM} , in real applications , should be limited by total power dissipation.

Typical Characteristics

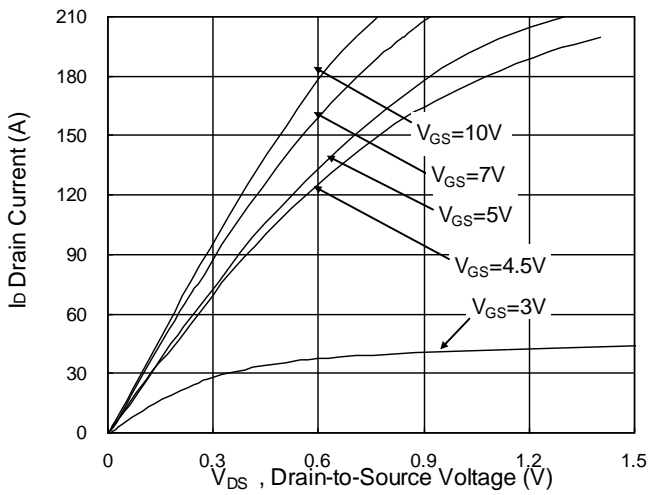


Fig.1 Typical Output Characteristics

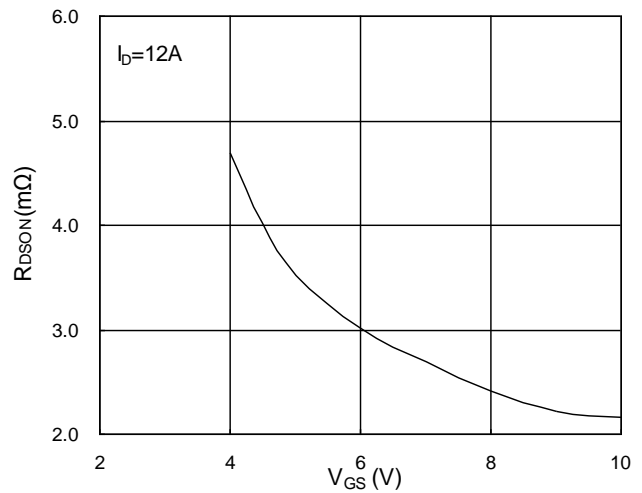


Fig.2 On-Resistance vs. G-S Voltage

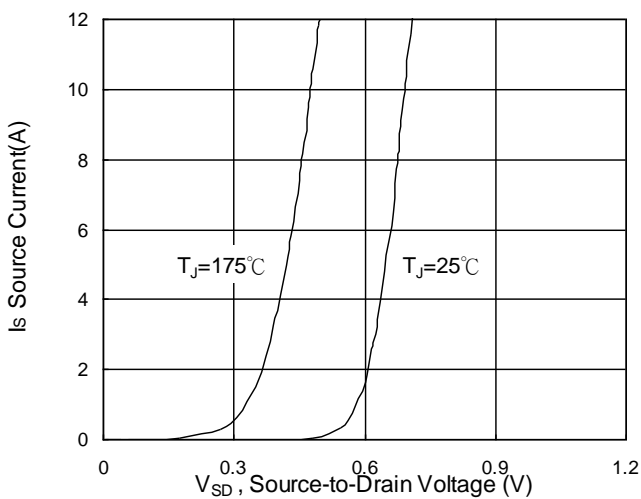


Fig.3 Forward Characteristics of Reverse

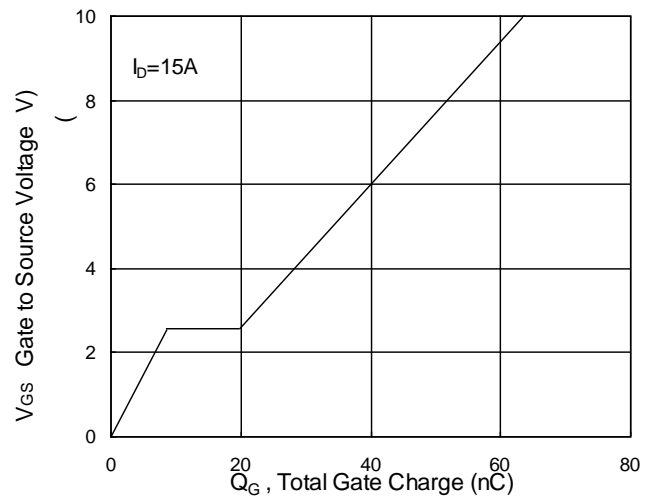


Fig.4 Gate-Charge Characteristics

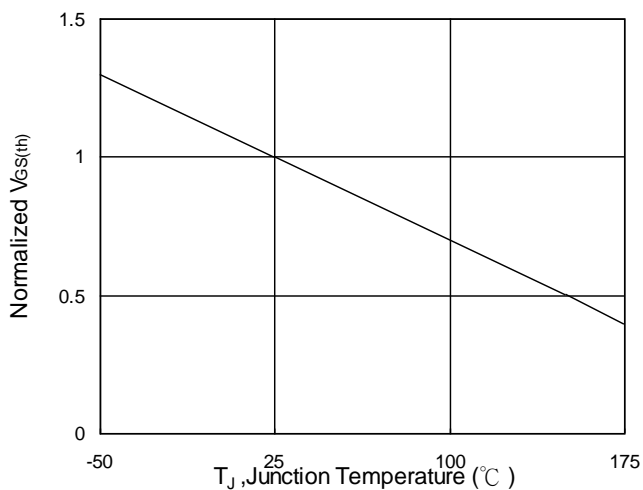


Fig.5 Normalized VGS(th) vs. Tj

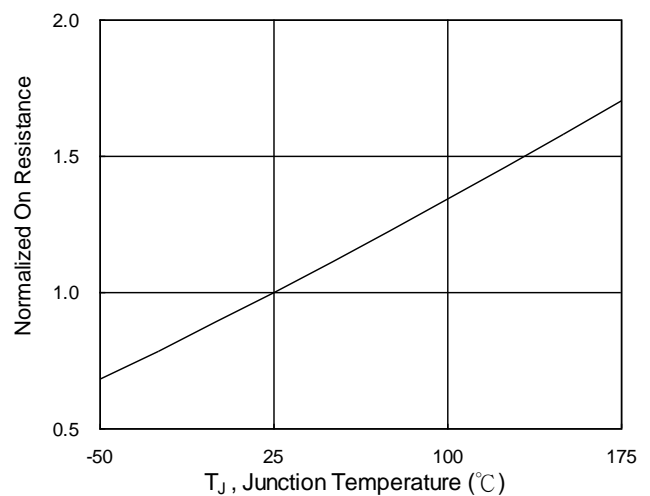


Fig.6 Normalized RDS(on) vs. Tj

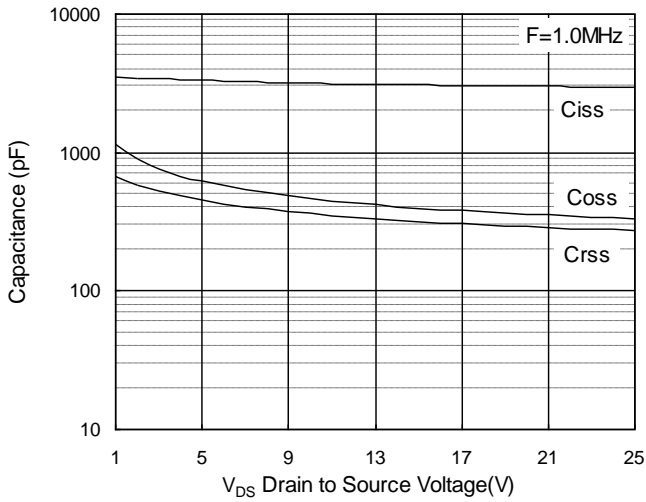


Fig.7 Capacitance

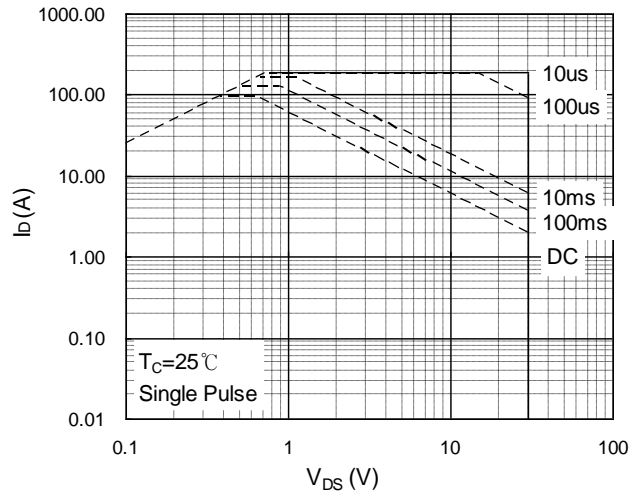


Fig.8 Safe Operating Area

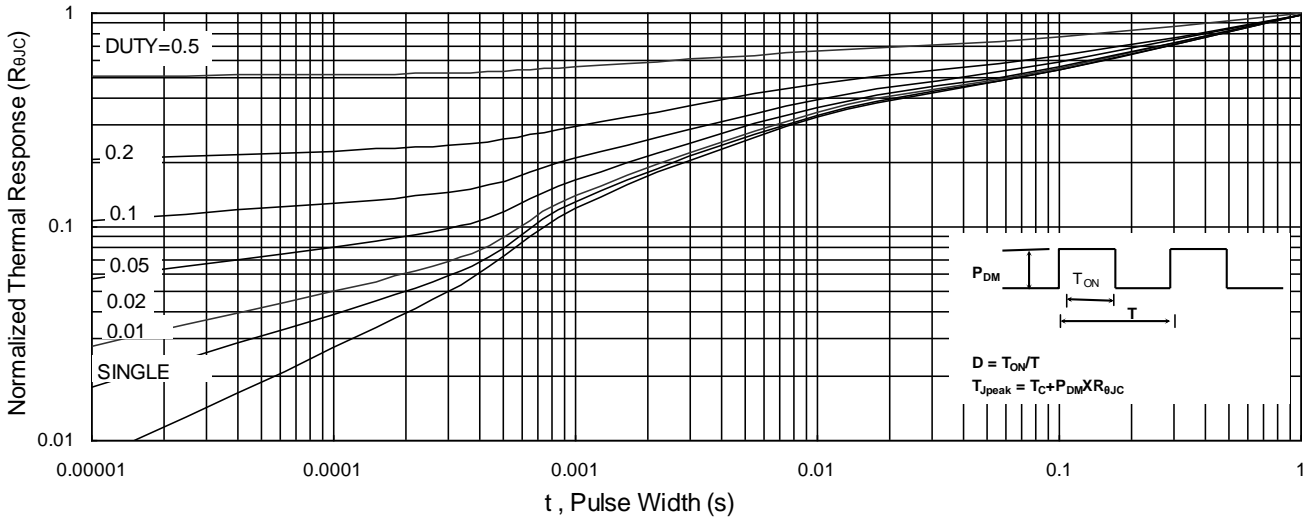


Fig.9 Normalized Maximum Transient Thermal Impedance

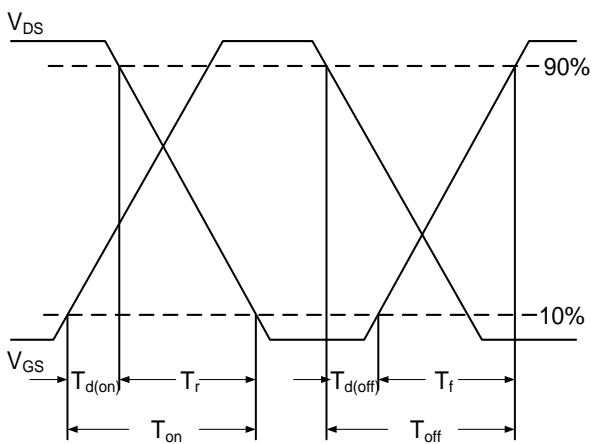


Fig.10 Switching Time Waveform

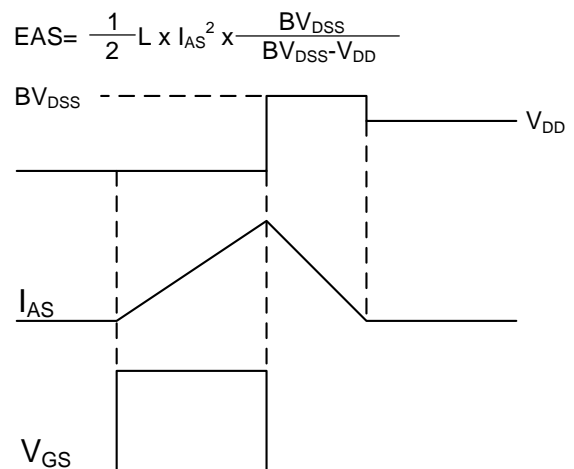


Fig.11 Unclamped Inductive Switching Waveform



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